



# +1.8V, Low Power, 16-Bit Sigma-Delta A/D Converter

### **Features**

- 16-bit Resolution at Eight Conversions Per Second, Adjustable Down to 10-bit Resolution at 512 Conversions Per Second
- 1.8V 5.5V Operation, Low Power Operating 260μA; Sleep: 0.75μA
- microPort<sup>™</sup> Serial Bus Requires only two Interface Lines
- Uses Internal or External Reference
- · Automatically Enters Sleep Mode when not in use

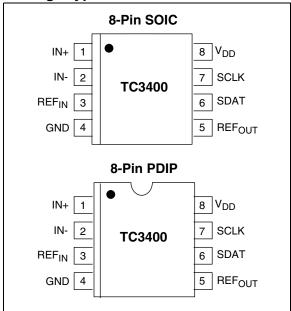
# **Applications**

- Consumer Electronics, Thermostats, CO Monitors, Humidity Meters, Security Sensors
- Embedded Systems, Data Loggers, Portable Equipment
- · Medical Instruments

### **Device Selection Table**

Part Number	Package	Temperature Range
TC3400VPA	8-Pin PDIP (Narrow)	0°C to +85°C
TC3400VOA	8-Pin SOIC (Narrow)	0°C to +85°C

# Package Type



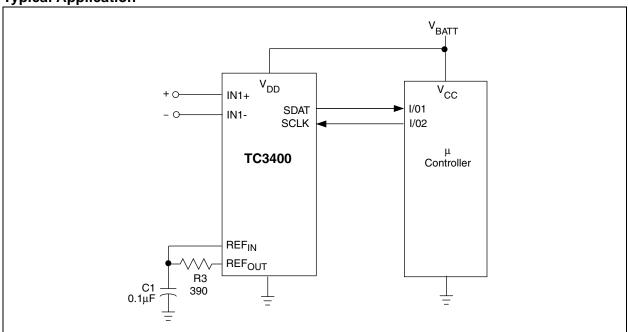
# **General Description**

The TC3400 is a low cost, low power analog-to-digital converter based on Microchip's Sigma-Delta technology. It will perform 16-bit conversions (15-bit plus sign) at up to eight per second. The TC3400 is optimized for use as a microcontroller peripheral in low cost, battery operated systems. A voltage reference is included, or an external reference can be used.

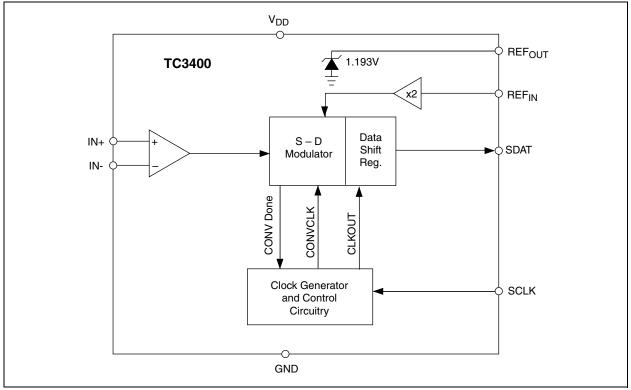
The TC3400's 2-wire microPort<sup>TM</sup> digital interface is used for starting conversions and for reading out the data. Driving the SCLK line low starts a conversion. After the conversion starts, each additional falling edge (up to six) detected on SCLK for  $t_4$  seconds reduces the A/D resolution by one bit and cuts conversion time in half. After a conversion is completed, clocking the SCLK line puts the MSB through LSB of the resulting data word onto the SDAT line, much like a shift register. The part automatically sleeps when not performing a data conversion.

The TC3400 is available in a 8-Pin PDIP and a 8-Pin SOIC package.

# **Typical Application**



# **Functional Block Diagram**



# 1.0 ELECTRICAL CHARACTERISTICS

# **Absolute Maximum Ratings\***

 \*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

# **TC3400 DC ELECTRICAL SPECIFICATIONS**

<b>Electrical Characteristics:</b> $T_A = 25^{\circ}C$ and $V_{DD} = 2.7V$ , unless otherwise specified. <b>Boldface</b> type specifications apply for temperatures of $0^{\circ}C$ to $85^{\circ}C$ . $V_{REF} = 1.25V$ , Internal Clock Frequency = $520$ kHz.								
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions		
Power Supply								
$V_{DD}$	Supply Voltage	1.8	_	5.5	V			
I <sub>DD</sub>	Supply Current, During Data Conversion	_	260		μΑ			
I <sub>DDSLEEP</sub>	Supply Current, Sleep Mode	_	0.75	1.5	μΑ	$T_A = +25$ °C		
		_	1.2	3.0	μΑ			
Accuracy (	Differential Inputs)							
RES	Resolution	_	16	_	Bits			
INL	Integral Non-Linearity	_	.0038	_	%FSR	V <sub>DD</sub> = 2.7V		
Vos	Offset Error	_	_	±0.9	%FSR	IN+, IN- = 0V		
V <sub>NOISE</sub>	Referred to input	_	60	l	μVrms			
CMR	Common Mode Rejection	_	75		dB	At DC		
FSE	Full Scale Error	_	0.4%		%FS			
PSRR	R Power Supply Rejection Ratio		75	_	dB	$V_{DD} = 2.5V \text{ to } 3.5V$		
IN+, IN-								
V <sub>IN</sub> ±	Differential Input Voltage		_	2.5	V	Note 1		
	Absolute Voltage Range on IN+, IN-	_	_	$V_{DD}$	V			
	Input Bias Current	_	1	100	nA			
C <sub>IN</sub>	Input Sampling Capacitance		2	_	pF			
R <sub>IN</sub>	Differential Input Resistance	_	2.0	_	$M\Omega$	Note 2		
REF <sub>IN,</sub> REF	оит							
$V_{REF}$	REF <sub>IN</sub> Voltage Range	0		1.25	V			
I <sub>REF</sub>	REF <sub>IN</sub> Input Current		1		μΑ			
V <sub>REFOUT</sub>	REF <sub>OUT</sub> Voltage		1.193		V			
REF <sub>SINK</sub>	REF <sub>OUT</sub> Current Sink Capability	_	10	_	μΑ			
REF <sub>SRC</sub>	REF <sub>OUT</sub> Current Source Capability	300	_	_	μΑ			

**Note** 1: Differential input voltage defined as  $(V_{IN} + - V_{IN})$ .

<sup>2:</sup> Resistance from INn+ to INn- or INn to GND.

# TC3400 DC ELECTRICAL SPECIFICATIONS (CONTINUED)

<b>Electrical Characteristics:</b> $T_A = 25^{\circ}C$ and $V_{DD} = 2.7V$ , unless otherwise specified. <b>Boldface</b> type specifications apply for temperatures of $0^{\circ}C$ to $85^{\circ}C$ . $V_{REF} = 1.25V$ , Internal Clock Frequency = $520 \text{kHz}$ .							
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
SCLK							
V <sub>IL</sub>	Input Low Voltage	_	_	0.3 x V <sub>DD</sub>	V		
$V_{IH}$	Input High Voltage	0.7 x V <sub>DD</sub>	_	_	V		
I <sub>LEAK</sub>	Leakage Current	_	1	_	μΑ		
SDAT							
V <sub>OL</sub>	Output Low Voltage	_	_	0.4	V	I <sub>OL</sub> = 1.5mA	
V <sub>OH</sub>	Output High Voltage (SDAT)	0.9 x V <sub>DD</sub>	_	_	V	I <sub>SOURCE</sub> = 400μA <b>(Note 3)</b>	

- Note 1: Differential input voltage defined as  $(V_{IN} + V_{IN})$ .
  - 2: Resistance from INn+ to INn- or INn to GND.
  - 3: @  $V_{DD}$  = 1.8V,  $I_{SOURCE} \le 200 \mu A$ .

# **TC3400 AC ELECTRICAL SPECIFICATIONS**

Resolution Reduction Window

SCLK to Data Valid

Acknowledge Delay

Electrical Characteristics:  $T_A = 25^{\circ}C$  and  $V_{DD} = 2.7V$ , unless otherwise specified. Boldface type specifications apply for temperatures of 0°C to 85°C.  $V_{REF} = 1.25V$ , Internal Clock Frequency = 520kHz. Symbol Min Unit **Test Conditions Parameter** Тур Max Resolution Reduction Clock Width 1 Width of SCLK (Negative) µsec Resolution Reduction Clock Width 1 Width of SCLK (Positive) µsec Conversion Time (15-bit Plus Sign) 125 16-bit Conversion, T<sub>A</sub> = 25°C (Note 1) msec  $t_3$ Conversion Time (14-bit Plus Sign)  $t_3/2.0$ msec 15-bit Conversion Conversion Time (13-bit Plus Sign)  $t_3/4.0$ msec 14-bit Conversion Conversion Time (12-bit Plus Sign)  $t_3/7.8$ 13-bit Conversion msec Conversion Time (11-bit Plus Sign)  $t_3/15.1$ msec 12-bit Conversion Conversion Time (10-bit Plus Sign)  $t_3/28.6$ msec 11-bit Conversion Conversion Time (9-bit Plus Sign)  $t_3/51.4$ msec 10-bit Conversion

 $t_3/85.7$ 

Note 1: Nominal temperature drift is -2830ppm/C° for temperature less than 25°C and -1340ppm/°C for temperatures greater than 25°C.

1000

 $t_4$ 

 $t_5$ 

t<sub>8</sub>

Width of SCLK

SCLK to SDAT Delay

SCLK Falling Edge to SDAT Valid

msec

nsec

nsec

1000

# 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (8-Pin SOIC) (8-Pin PDIP)	Symbol	Description		
1	IN+	Analog Input. This is the positive terminal of a true differential input consisting of IN+ and IN $V_{IN1} = (IN+ - IN-)$ . See Section 1.0 Electrical Characteristics.		
2	IN-	Analog Input. This is the negative terminal of a true differential input consisting of IN+ and IN $V_{IN} = (IN+-IN-)$ IN- can swing to, but not below, ground.		
3	REF <sub>IN</sub>	Analog Input. The converter's reference voltage is the differential between this pin and ground times two. It may be tied directly to REF <sub>OUT</sub> or scaled using a resistor divider. Any user supplied reference voltage less than 1.25V may be used in place of REF <sub>OUT</sub> .		
4	GND	Ground Terminal.		
5	REF <sub>OUT</sub>	Analog Output. The internal reference connects to this pin. It may be scaled externally, if desired, and tied to the REF <sub>IN</sub> input to provide the converter's reference voltage. Care must be taken in connecting external circuitry to this pin.		
6	SDAT	Digital Output (push-pull). This is the microPort™ serial data output. SDAT is driven low while the TC3400 is converting data, effectively providing a "busy" signal. After the conversion is complete, every high to low transition on the SCLK pin puts a bit from the resulting data word on the SDAT pin (from MSB to LSB).		
7	SCLK	Digital Input. This is the microPort™ serial clock input. The TC3400 comes out of sleep mode and a conversion cycle begins when this pin is driven low. After the conversion starts, each additional falling edge (up to six) detected on SCLK for t₄ seconds reduces the A/D resolution by one bit. When the conversion is complete, the data word can be shifted out on the SDAT pin by clocking the SCLK pin.		
8	$V_{DD}$	Power Supply Input.		

# 3.0 DETAILED DESCRIPTION

The TC3400 is a 16-bit sigma-delta A/D converter with one differential input. See the Typical Application circuit and the Functional Block diagram. The key components of the TC3400 are described below.

Also refer to Figure 3-4, A/D Operational Flowchart and the Timing Diagrams, Figure 3-1, Figure 3-2 and Figure 3-3).

# 3.1 A/D Converter Operation

When the TC3400 is not converting, it is in sleep mode with both the SCLK and SDAT lines high. An A/D conversion is initiated by a high to low transition on the SCLK line at which time the internal clock of the TC3400 is started. Each additional high to low transition of SCLK (following the initial SCLK falling edge) during the time interval  $t_4$ , will decrement the conversion resolution by one bit and reduce the conversion time by one half. The time interval  $t_4$  is referred to as the resolution reduction window. The minimum conversion resolution is 10-bits so any more than 6 SCLK transitions during  $t_4$  will be ignored.

After each high to low transition of SCLK, in the  $t_4$  interval, the SDAT output is driven high by the TC3400 to acknowledge that the conversion has been decremented. When the SCLK returns high or the  $t_4$  interval ends, the SDAT line returns low (see Figure 3-2). When the conversion is complete SDAT is driven high. The TC3400 now enters sleep mode and the conversion value can be read as a serial data word on the SDAT line.

# 3.2 Reading the Data Word

After the conversion is complete and SDAT goes high, the conversion value can be clocked serially onto the SDAT line by high to low transitions of the SCLK. The data word is in two's compliment format with the sign bit clocked onto the SDAT line, first followed by the MSB and ending in the LSB. For a 16-bit conversion the data word would consist of a sign bit followed by 15 magnitude bits, Table 3-1 shows the data word versus input voltage for a 16-bit conversion. Note that the full scale input voltage range is  $\pm (2~{\rm REF_{IN}}-1{\rm LSB})$ . When  ${\rm REF_{OUT}}$  is fed back directly to  ${\rm REF_{IN}}$ , an LSB is  $73\mu{\rm V}$  for a 16-bit conversion, as  ${\rm REF_{OUT}}$  is typically 1.193V.

Figure 3-3 shows typical SCLK and SDAT waveforms for 16, 12 and 10-bit conversions. Note that any complete convert and read cycle requires 17 negative edge clock pulses. The first is the convert command. Then, up to six of these can occur in the resolution reduction window,  $t_4$ , to decrement resolution. The remaining pulses clock out the conversion data word.

TABLE 3-1: DATA CONVERSION WORD VS. VOLTAGE INPUT (REF<sub>IN</sub> = 1.193V)

Data Word	INn+ - INn- (Volts)
0111 1111 1111 1111	2.38596 (Positive Full Scale)
0000 0000 0000 0001	72.8 E -6
0000 0000 0000 0000	0
1111 1111 1111 1111	-72.8 E -6
1000 0000 0000 0001	-2.38596 (Negative Full Scale)
1000 0000 0000 0000	Reserved Code

The SCLK input has a filter which rejects any positive or negative pulse of width less than 50nsec to reduce noise. The rejection width of this pulse can vary between 50nsec and 750nsec depending on processing parameters and supply voltage.

Figure 3-1 and Table 3-2 show information for determining the mode of operation for the TC3400 part by recording the value of SDAT for SCLK in a high, then low, then high state. For example, if SCLK goes through a 1-0-1 transition and the corresponding values of SDAT are 1-1-0, then the SCLK falling edge started a new data conversion. A 0-1-0 for SDAT would have indicated a resolution reduction had occurred. This is useful if the microcontroller has a watchdog reset or otherwise loses track of where the TC3400 is in the conversion and data readout sequence. The microcontroller can simply transition SCLK until it "finds" a Start Conversion condition.

FIGURE 3-1: SCLK, SDAT LOGIC STATE DIAGRAM

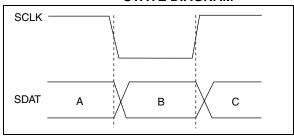
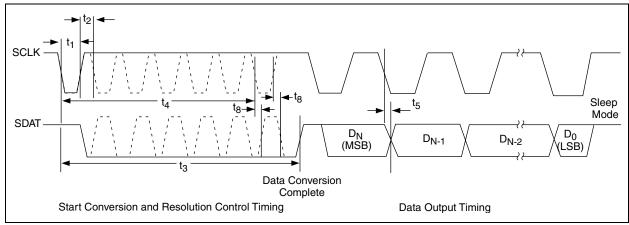


TABLE 3-2: SCLK, SDAT LOGIC STATE

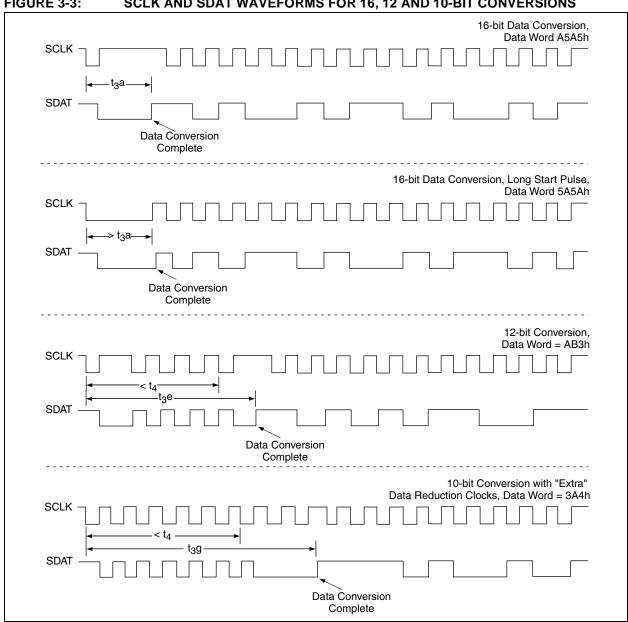
Α	В	С	Status		
1	1	0	Start Conversion		
0	1	0	Resolution Reduction		
Х	1	1	Data Transfer		
Х	0	0	Data Transfer or Busy*		

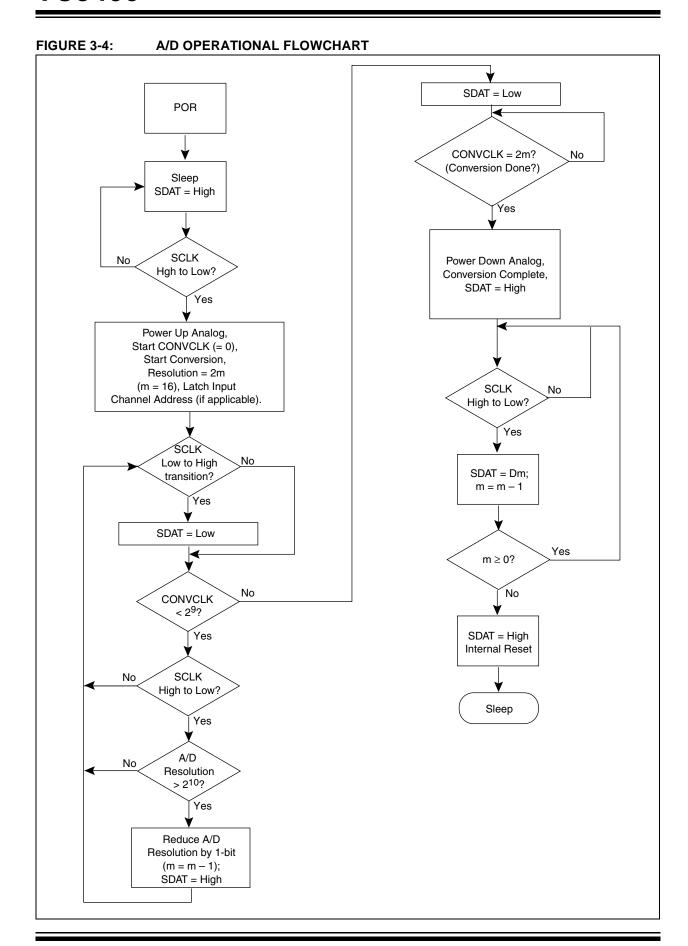
\*Note: The code X00 has a dual meaning: Data Transfer or Busy converting. To avoid confusion, the user should send only the required number of pulses for the desired resolution, then wait for SDAT to rise to 1, indicating conversion is complete before clocking SCLK again to read out data bits.





### FIGURE 3-3: SCLK AND SDAT WAVEFORMS FOR 16, 12 AND 10-BIT CONVERSIONS





# 4.0 PACKAGING INFORMATION

# 4.1 Package Marking Information

Package marking data not available at this time.

# 4.2 Taping Forms

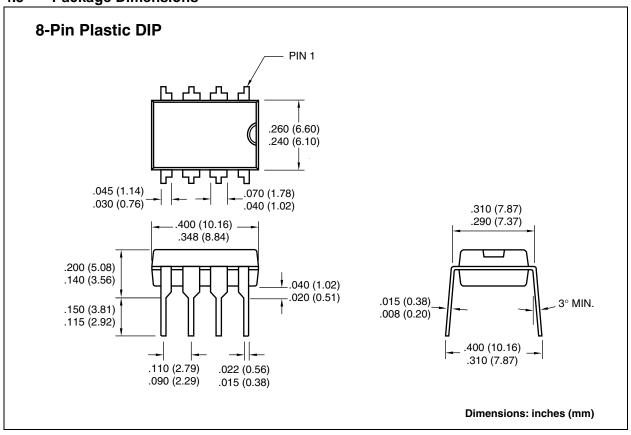
# Component Taping Orientation for 8-Pin SOIC (Narrow) Devices User Direction of Feed W PIN 1 P P

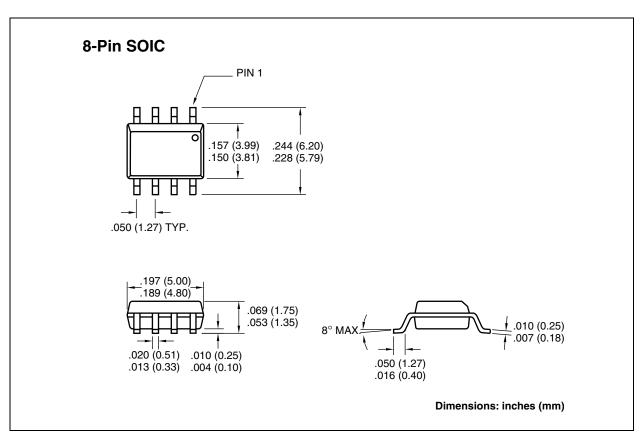
Standard Reel Component Orientation for TR Suffix Device

# Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin SOIC (N)	12 mm	8 mm	2500	13 in

# 4.3 Package Dimensions





NOTES:

# **TC3400**

NOTES:

# **SALES AND SUPPORT**

# Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- Your local Microchip sales office
- 1. 2. The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
- The Microchip Worldwide Site (www.microchip.com) 3.

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System
Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

# **TC3400**

**NOTES:** 

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

### **Trademarks**

The Microchip name and logo, the Microchip logo, FilterLab, KEELOQ, microID, MPLAB, PIC, PICmicro, PICMASTER, PICSTART, PRO MATE, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

dsPIC, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, MXDEV, PICC, PICDEM, PICDEM.net, rfPIC, Select Mode and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A.

Serialized Quick Turn Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2002, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.





Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999 and Mountain View, California in March 2002. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, non-volatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.



# WORLDWIDE SALES AND SERVICE

### **AMERICAS**

### **Corporate Office**

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: 480-792-7627 Web Address: http://www.microchip.com

### **Rocky Mountain**

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7966 Fax: 480-792-7456

### Atlanta

500 Sugar Mill Road, Suite 200B Atlanta, GA 30350

Tel: 770-640-0034 Fax: 770-640-0307

### **Boston**

2 Lan Drive, Suite 120 Westford, MA 01886 Tel: 978-692-3848 Fax: 978-692-3821

### Chicago

333 Pierce Road, Suite 180 Itasca, IL 60143

Tel: 630-285-0071 Fax: 630-285-0075

### **Dallas**

4570 Westgrove Drive, Suite 160 Addison, TX 75001 Tel: 972-818-7423 Fax: 972-818-2924

### Detroit

Tri-Atria Office Building 32255 Northwestern Highway, Suite 190 Farmington Hills, MI 48334 Tel: 248-538-2250 Fax: 248-538-2260

### Kokomo

2767 S. Albright Road Kokomo, Indiana 46902

Tel: 765-864-8360 Fax: 765-864-8387

# Los Angeles

18201 Von Karman, Suite 1090 Irvine, CA 92612

Tel: 949-263-1888 Fax: 949-263-1338

# **New York**

150 Motor Parkway, Suite 202 Hauppauge, NY 11788 Tel: 631-273-5305 Fax: 631-273-5335

# San Jose

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

6285 Northam Drive, Suite 108 Mississauga, Ontario L4V 1X5, Canada Tel: 905-673-0699 Fax: 905-673-6509

### ASIA/PACIFIC

### Australia

Microchip Technology Australia Pty Ltd Suite 22, 41 Rawson Street Epping 2121, NSW Australia

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

### China - Beijing Microchip Technology Consulting (Shanghai)

Co., Ltd., Beijing Liaison Office Unit 915 Bei Hai Wan Tai Bldg.

No. 6 Chaoyangmen Beidajie Beijing, 100027, No. China Tel: 86-10-85282100 Fax: 86-10-85282104

### China - Chengdu

Microchip Technology Consulting (Shanghai) Co., Ltd., Chengdu Liaison Office Rm. 2401, 24th Floor, Ming Xing Financial Tower No. 88 TIDU Street Chengdu 610016, China Tel: 86-28-86766200 Fax: 86-28-86766599

### China - Fuzhou

Microchip Technology Consulting (Shanghai) Co., Ltd., Fuzhou Liaison Office Unit 28F, World Trade Plaza No. 71 Wusi Road Fuzhou 350001, China Tel: 86-591-7503506 Fax: 86-591-7503521

## China - Shanghai

Microchip Technology Consulting (Shanghai)

Co., Ltd. Room 701, Bldg. B Far East International Plaza No. 317 Xian Xia Road Shanghai, 200051

Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

### China - Shenzhen

Microchip Technology Consulting (Shanghai) Co., Ltd., Shenzhen Liaison Office Rm. 1315, 13/F, Shenzhen Kerry Centre, Renminnan Lu

Shenzhen 518001, China

Tel: 86-755-2350361 Fax: 86-755-2366086

# China - Hong Kong SAR

Microchip Technology Hongkong Ltd. Unit 901-6, Tower 2, Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

### India

Microchip Technology Inc. India Liaison Office Divvasree Chambers 1 Floor, Wing A (A3/A4) No. 11, O'Shaugnessey Road Bangalore, 560 025, India Tel: 91-80-2290061 Fax: 91-80-2290062

### Japan

Microchip Technology Japan K.K. Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa, 222-0033, Japan

Tel: 81-45-471-6166 Fax: 81-45-471-6122

### Korea

Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea 135-882

Tel: 82-2-554-7200 Fax: 82-2-558-5934

### Singapore

Microchip Technology Singapore Pte Ltd. 200 Middle Road #07-02 Prime Centre Singapore, 188980 Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan

Microchip Technology Taiwan 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

### **EUROPE**

### Denmark

Microchip Technology Nordic ApS Regus Business Centre Lautrup hoj 1-3 Ballerup DK-2750 Denmark Tel: 45 4420 9895 Fax: 45 4420 9910

### France

Microchip Technology SARL Parc d'Activite du Moulin de Massy 43 Rue du Saule Trapu Batiment A - ler Etage 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

# Germany

Microchip Technology GmbH Gustav-Heinemann Ring 125 D-81739 Munich, Germany Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

# Italy

Microchip Technology SRL Centro Direzionale Colleoni Palazzo Taurus 1 V. Le Colleoni 1 20041 Agrate Brianza Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

**United Kingdom** Microchip Ltd. 505 Eskdale Road Winnersh Triangle Wokingham

Berkshire, England RG41 5TU

Tel: 44 118 921 5869 Fax: 44-118 921-5820

05/01/02



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# Microchip:

TC3400VOATR TC3400VPA TC3400VOA